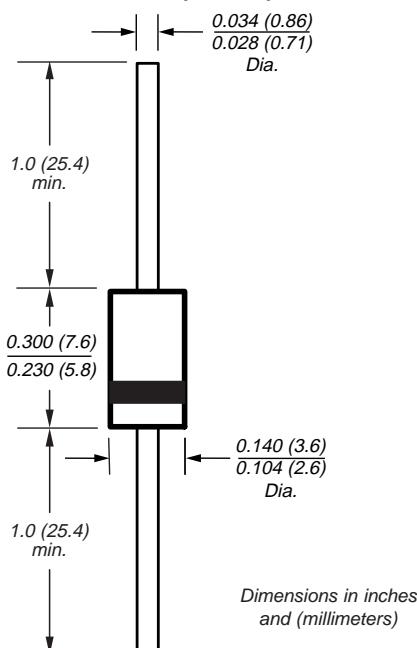




Ultrafast Plastic Rectifier

DO-204AC (DO-15)

 Reverse Voltage 50 to 200V
 Forward Current 2.0A

Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Ideally suited for use in very high frequency switching power supplies, inverters and as free wheeling diodes
- Ultrafast recovery time for high efficiency
- Excellent high temperature switching
- Soft recovery characteristics
- Glass passivated junction
- High temperature soldering guaranteed:
250°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

Mechanical Data

Case: JEDEC DO-204AC molded plastic body over passivated chip

Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.015 oz., 0.4 g

Maximum Ratings & Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	UG2A	UG2B	UG2C	UG2D	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	V
Maximum average forward rectified current at 0.375" (9.5mm) lead length at T _L = 75°C	I _{F(AV)}			2.0		A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method) at T _L = 75°C	I _{FSM}			80		A
Typical thermal resistance (NOTE 1)	R _{θJA}			45		°C/W
Operating junction and storage temperature range	T _J , T _{STG}			-55 to +150°C		°C

Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Maximum instantaneous forward voltage at 2.0A (NOTE 2)	V _F	0.95	V
Maximum DC reverse current T _A = 25°C at rated DC blocking voltage T _A = 100°C	I _R	5.0 200	µA
Maximum reverse recovery time at I _F =0.5A, I _R =1.0A, I _{rr} =0.25A	t _{rr}	15	ns
Maximum reverse recovery time at I _F =2.0A, V _R =30V, di/dt=50A/µs, I _{rr} =10% I _{RM} T _J = 25°C T _J = 100°C	t _{rr}	25 35	ns
Maximum recovered stored charge I _F =2.0A, V _R =30V, di/dt=50A/µs, I _{rr} =10% I _{RM} T _J = 25°C T _J = 100°C	Q _{RR}	10 22	nC
Typical junction capacitance at 4V, 1MHz	C _J	15	pF

Notes:

(1) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length

(2) Pulse test: 300µs pulse width, 1% duty cycle

UG2A thru UG2D

Vishay Semiconductors
formerly General Semiconductor



Ratings and Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 — Maximum Forward Current Derating Curves

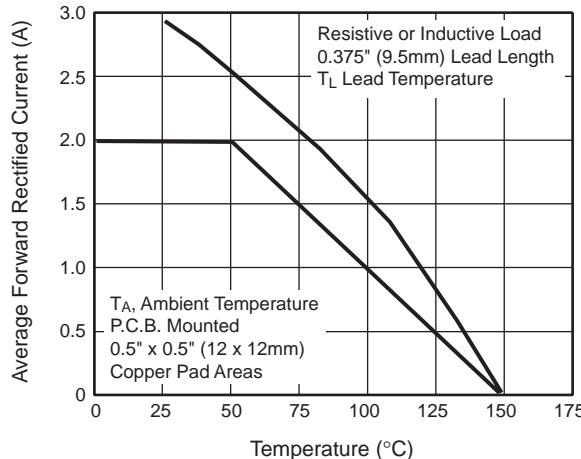


Fig. 2 — Maximum Non-Repetitive Peak Forward Surge Current

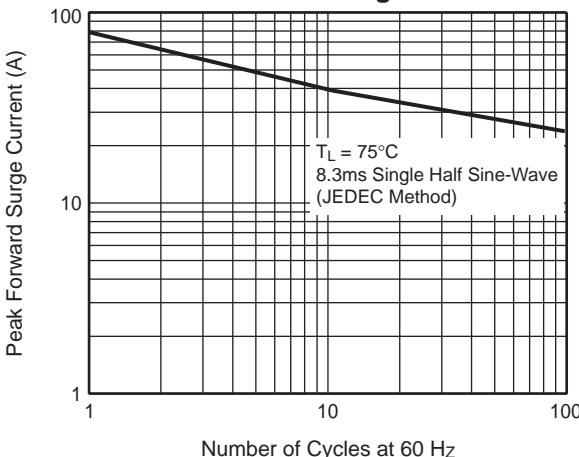


Fig. 3 — Typical Instantaneous Forward Characteristics

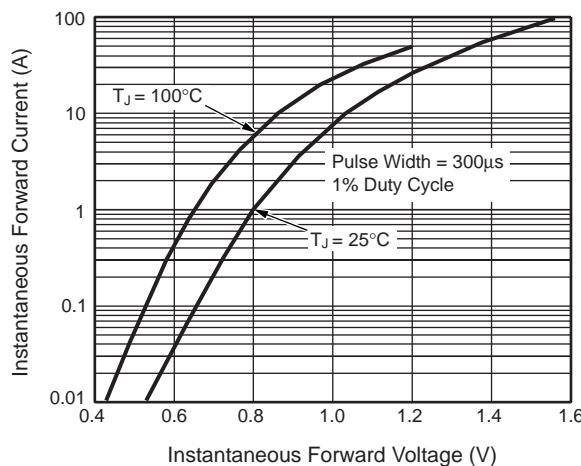


Fig. 4 — Typical Reverse Leakage Characteristics

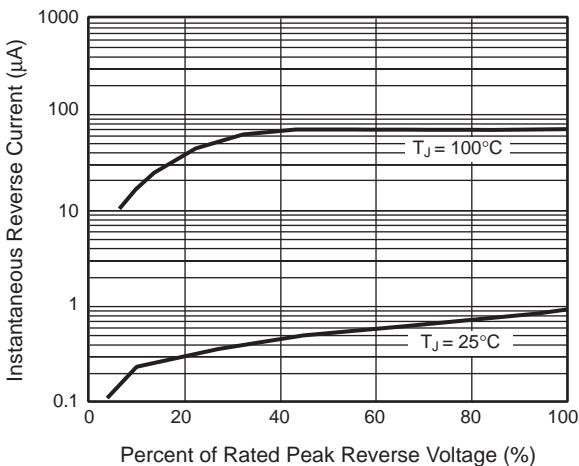


Fig. 5 — Reverse Switching Characteristics

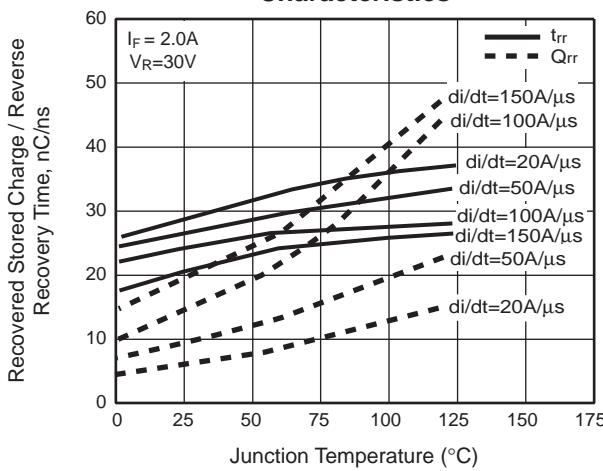


Fig. 6 — Typical Junction Capacitance

